





NSL-7910

Light Dependent Resistor (LDR) CdS Photocell

The NSL-7910 is a Light Dependent Resistor with sensitivity in the visible light region. The CdS photoresistor cell is mounted in a TO-8 hermetically sealed package.

Advanced Photonix's CdS Photocells are photoresistor cells for visible light measurement designed to sense light from 400 to 700 nm. Their resistance decreases as the light level increases with efficiency characteristics similar to the human eye. These Light Dependent Resistors (LDR) are available in a wide range of resistance values. They are available in a two-leaded plastic-coated ceramic header or hermetically sealed TO metal cans.

Applications

Industrial Audio Compressors Night Lights Photography Light Meters Solar Street Lights Flame Detection

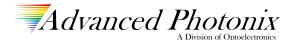
Features

Passive Resistance output

Hermetically Sealed Package

Available in a two-leaded ceramic package

Available in a wide range of resistance values





Absolute Maximum Ratings at T_A=23 °C

| Parameter | Symbol | Min | Max | Unit | | | |
|-----------------------|---------------------|-----|-----|------|--|--|--|
| Voltage | $V_{_{\mathrm{R}}}$ | - | 250 | V | | | |
| Power Dissipation* | - | - | 500 | mW | | | |
| Operating Temperature | T _{OP} | -40 | +75 | °C | | | |
| Storage Temperature | T _{stg} | -55 | +75 | °C | | | |
| Package | TO-8 | | | | | | |

^{*}Derate linearly to zero at 75°C

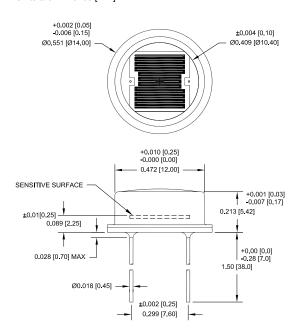
Typical Electro-Optical Specifications at T_A=23 °C

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|------------------|----------------------------------|----------------------------|-----|-----|-----|------|
| Light Resistance | 2ftc., 2854°K | $R_{\scriptscriptstyle L}$ | 5.5 | 7.5 | 10 | ΚΩ |
| | 100 ftc.,2854°K | $R_{\scriptscriptstyle L}$ | - | 800 | - | Ω |
| Dark Resistance | 5sec after removal of test light | $R_{_{D}}$ | 1.5 | - | - | ΜΩ |
| Spectral Peak | - | λ | - | 615 | - | nm |

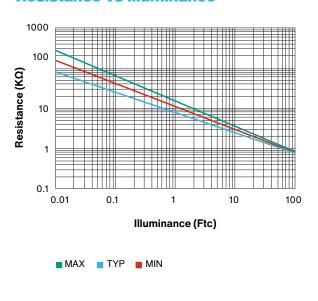
Cells light adapted at 30 to 50 ftc for 16 hrs minimum prior to electrical tests

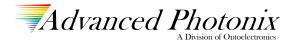
Mechanical Specifications

Units are in inches [mm]



Resistance vs Illuminance







Care and handling instructions

Your optoelectronic components are packaged and shipped in opaque, padded containers to avoid ambient light exposure and damage due to shock from dropping or jarring.

Care must be taken to avoid exposure to high ambient light levels, particularly from tungsten sources or sunlight.

- These components can be rendered inoperable
 if dropped or sharply jarred. The wire bonds are
 delicate and can become separated from the
 bonding pads when the component is dropped or
 otherwise receives a sharp physical blow.
- Most windows on photodiodes are either silicon or quartz. They should be cleaned with isopropyl alcohol and a soft (optical grade) pad.
- Photodiode exposure to extreme high or low storage temperatures can affect the subsequent performance. Maintain a non-condensing environment for optimum performance and lifetime.
- All devices are considered ESD sensitive.
 The photodiodes are shipped in ESD protective packaging. When unpacking and using these products, anti-ESD precautions should be observed.
- Photodiode packages and/or operation may be impaired if exposed to CHLOROETHENE, THINNER, ACETONE, TRICHLOROETHYLENE or any harsh chemicals.
- Legal Disclaimer

Information in this data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice.

- Optoelectronic components in plastic packages should be given special care. Clear plastic packages are more sensitive to environmental stress than those of black plastic. Storing devices in high humidity can present problems when soldering. Since the rapid heating during soldering stresses the wire bonds and can cause wire to bonding pad separation, it is recommended that devices in plastic packages to be baked for 24 hours at 85°C.
- The leads on the photodiode SHOULD NOT BE FORMED. If your application requires lead spacing modification, please contact Advanced Photonix Applications group at Techsupport@advancedphotonix.com before forming a product's leads. Product warranties could be voided.
- Most devices are provided with wire or pin leads for installation in circuit boards or sockets. Observe the soldering temperatures and conditions specified below:
 - Soldering Iron: Soldering 30 W or less
 - Temperature at tip of iron 300°C or lower.
 - Dip Soldering: Bath Temperature: 260±5°C.
 - Immersion Time: within 5 Sec.
 - Soldering Time: within 3 Sec.
 - Vapor Phase Soldering, Reflow Soldering: DO NOT USE



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Photoresistors category:

Click to view products by Advanced Photonix manufacturer:

Other Similar products are found below:

NSL-6510 NSL 4960 NSL-5540 NSL-5510 NSL-5910 NSL-6110 NSL-6910 NSL-7910 PDV-P5001 PDV-P7002 PDV-P5003 PDV-P8005 PDV-P8101 PDV-P9002-1 PDV-P9003 NSL-5112 PDV-P9001 PDV-P8103 PDV-P9008 NSL-5162 PDV-P8104 NSL-6112 PDV-P9002 PDV-P9004 PDV-P9007 PDV-P9103 PDV-P9203 NSL 06S53